

ABSTRACT

METAL FOIL WITH CARRIER

5 Provided is a metal foil with a carrier as a laminated body in which a carrier
A and a metal foil B are placed alternately, wherein the metal foil with a carrier
comprises a structure where the adjoining carrier A has an area which covers the
entire surface of the metal foil B, and the edge of the carrier A protrudes partially or
entirely from the metal foil B. The copper foil with a carrier is used for producing a
single-sided laminated plate or a multilayer laminated plate of two or more layers or
an ultrathin coreless substrate for use in a printed wiring board. In particular, this
10 copper foil with a carrier is used for producing a laminated plate, and its objective is to
improve the handling performance in the production process of a printed board and
reduce costs by increasing the yield.

Fig.1